

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Yasuhiro SHIRAI</td><td>05/29/2007</td></tr><tr><td>Toshihiro MORITA</td><td>05/29/2007</td></tr><tr><td>Taku SUGAWARA</td><td>05/30/2007</td></tr><tr><td>Shin OGATA</td><td>05/29/2007</td></tr><tr><td>Susumu MORITA</td><td>06/01/2007</td></tr></tbody></table>	Name	Execution Date	Yasuhiro SHIRAI	05/29/2007	Toshihiro MORITA	05/29/2007	Taku SUGAWARA	05/30/2007	Shin OGATA	05/29/2007	Susumu MORITA	06/01/2007	
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RECEIVING PARTY DATA													
<table border="1"><tr><td>Name:</td><td>Sony Corporation</td></tr><tr><td>Street Address:</td><td>1-7-1 Konan, Minato-ku</td></tr><tr><td>City:</td><td>Tokyo</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr><tr><td>Postal Code:</td><td>108-0075</td></tr></table>	Name:	Sony Corporation	Street Address:	1-7-1 Konan, Minato-ku	City:	Tokyo	State/Country:	JAPAN	Postal Code:	108-0075			
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PROPERTY NUMBERS Total: 1													
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Application Number:	11734405												
CORRESPONDENCE DATA													
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ATTORNEY DOCKET NUMBER:	307000US												
NAME OF SUBMITTER:	Gafar Kangam												

OP \$40.00 11734405

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PATENT  
REEL: 019456 FRAME: 0359

Total Attachments: 2

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**PATENT**

**REEL: 019456 FRAME: 0360**

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in  
**INFORMATION PROCESSING APPARATUS, INFORMATION PROCESSING METHOD, AND PROGRAM**  
 for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-ku, Tokyo 108-0075 Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/734,405  
 Filing Date: April 12, 2007

This assignment executed on the dates indicated below.

Yasuhiro SHIRAI

Name of first or sole inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of first or sole inventor

Yasuhiro Shirai

May 29th, 2007

Signature of first or sole inventor

Date of this assignment

Toshihiro MORITA

Name of second inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of second inventor

Toshihiro Morita

May 29th, 2007

Signature of second inventor

Date of this assignment

Taku SUGAWARA

Name of third inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of third inventor

Taku Sugawara

May 30th, 2007

Signature of third inventor

Date of this assignment

Shin OGATA

Name of fourth inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of fourth inventor

Shin Ogata

May 29th, 2007

Signature of fourth inventor

Date of this assignment

Susumu MORITA

Name of fifth inventor

Execution date of U.S. Patent Application

Saitama, Japan

Residence of fifth inventor

Susumu Morita

Jun 1st, 2007

Signature of fifth inventor

Date of this assignment